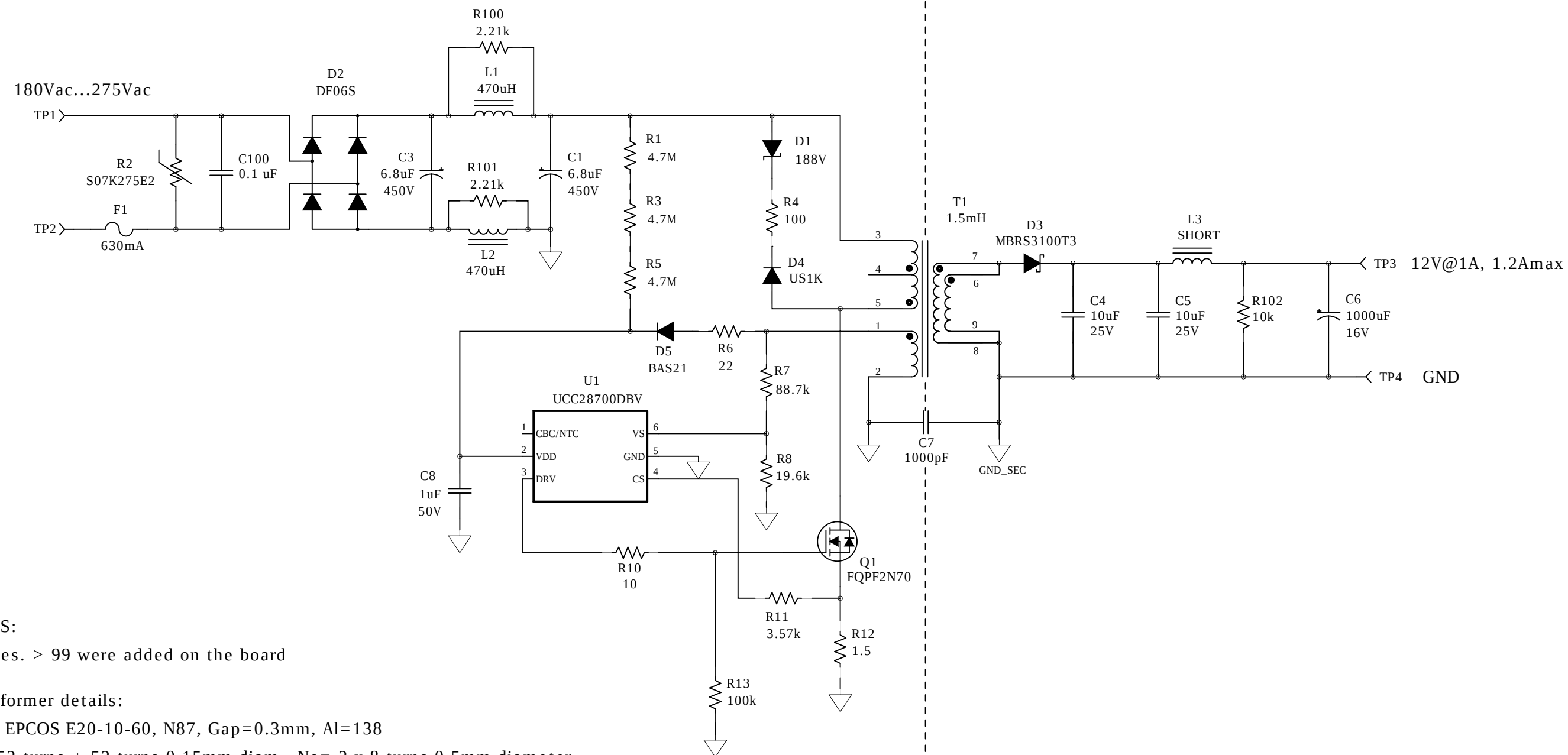




NOTES:

Ref.Des. > 99 were added on the board

Transformer details:

Core: EPCOS E20-10-60, N87, Gap=0.3mm, Al=138

Np= 52 turns + 52 turns 0.15mm diam., Ns= 2 x 8 turns 0.5mm diameter

Naux = 14 turns 0.15mm diam.

Wind first half primary, then secondary, auxiliary, and finally the remaining half primary.

Start windings on pins with the dots



Title 180...275Vac to 12V@1A		
Size B	Number PMP7249	Rev B
Date 12/18/2012	Drawn by R. Scibilia	
Filename PMP7249 Rev_B pads.sch	Sheet 1	of 1

Engineer R. Scibilia

12/18/2012

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